

PATENT

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

In Re Patent Application of: **Kuei-Wu Huang, et al.**

Serial No.: **10/687,713**

Group Art Unit: **1765**

Filed: **October 17, 2003**

Examiner: **L. Vinh**

For: **SURFACE TREATED LOW-K DIELECTRIC AS DIFFUSION BARRIER FOR
COPPER METALLIZATION**

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

AMENDMENT AND RESPONSE

Sir:

In response to the Office Action of January 6, 2006, please amend the above-identified application as follows:

Amendments to the Claims are reflected in the listing of claims which begins on page 2 of this paper.

Remarks begin on page 5 of this paper.